

SecureVision X100 — Product & Procurement Design Specification

1. Document Overview

Document Title: SecureVision X100 — Procurement & Design Spec

Version: 1.0

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Author(s):

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- Ryan Matthews (Systems Design Lead)

Purpose:

This document outlines technical and procurement requirements for the SecureVision X100—an advanced modular security camera system for industrial and commercial use. It includes the BOM, procurement stages (RFI/RFQ/RFP), vendor profiles, pricing details, and milestone timelines.

2. Project Details

Project Name/Code: SecureVision X100

Brief Description:

The SecureVision X100 is a next-gen modular camera system offering 4K resolution, night vision, AI-powered motion detection, and wireless cloud connectivity. It supports PoE (Power over Ethernet) and edge computing for real-time analytics.

3. Stakeholders & Roles

3.1 Engineering Team

Name	Role/Title	Responsibilities	Contact Info
Ryan Matthews	Systems Design Lead	Oversees system architecture & firmware specs	r.matthews@securevision.ai

Lila Wong	Optics Engineer	Lens calibration, low-light optimization	l.wong@securevision.ai
Amit Shah	Edge AI Specialist	Develops onboard analytics & motion detection AI	a.shah@securevision.ai

3.2 Procurement Team

Name	Role/Title	Responsibilities	Contact Info
Priya Malhotra	Procurement Manager	Manages RFI/RFQ/RFP and vendor negotiation	p.malhotra@securevision.ai
Jacob Fisher	Sourcing Specialist	Identifies suppliers and initiates outreach	j.fisher@securevision.ai
Alan Rivera	Contracts Analyst	Legal compliance and contract finalization	a.rivera@securevision.ai

3.3 Executive Sponsors

Name	Title	Scope of Approval	Contact Info
Melissa Grant	COO	Product milestones & rollout	m.grant@securevision.ai
Daniel Yu	CFO	Budget & financial approvals	d.yu@securevision.ai

4. Bill of Materials (BOM) & Key Specifications

Item	Technical Spec	Qty	Vendors	Notes
4K CMOS Image Sensor	3840x2160, HDR, global shutter	8,000	2 Vendors	Must support wide dynamic range
Edge Compute Module (ARM)	6-core ARM + 2 TOPS NPU, 4GB LPDDR4	8,000	1 Vendor	Needed for onboard analytics
Housing (IP66 Aluminum)	Weatherproof, anti-tamper, IK10	8,000	3 Vendors	Supports wall & ceiling mounting
IR Night Vision LEDs	850nm, 30m visibility	8,000	2 Vendors	Needs UL compliance

PoE Connectivity Chipset	IEEE 802.3af/at compliant	8,000	1 Vendor	Must support 15.4W and 30W modes
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5. Procurement Activities

5.1 RFI (Request for Information)

Title/ID: RFI-501 — PoE Chipsets for Security Modules

Objective: Identify chipsets compliant with PoE+ (IEEE 802.3at) for camera units

Date Issued: April 16, 2025

Due Date: April 29, 2025

Scope:

- Energy efficiency benchmarks
- Support for power surge protection
- Thermal design recommendations

Vendors Responded:

- TechEdge Systems (pending clarification)
 - NanoSwitch Co. (response due Apr 24)
 - VoltPro Inc. (preliminary data sent)
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5.2 RFQ (Request for Quote)

Title/ID: RFQ-602 — IR LED Modules

Date Issued: April 14, 2025

Deadline: April 21, 2025

Specs:

- 850nm wavelength
- ≥30m night visibility

- 10,000-hour lifespan

Vendor Quotes:

- **IllumiTech Co.:** \$3.20/unit, 5-week lead, Net 30
- **OptoView Ltd.:** \$3.10/unit, 6-week lead, 30% upfront

5.3 RFP (Request for Proposal)

Title/ID: RFP-703 — Edge Module + AI Software
Issued: April 13, 2025
Due: May 1, 2025

Scope:

- Edge AI module with SDK for motion detection, facial blur
- Integration with SecureVision firmware
- 1-year support + optional OTA updates

Vendors:

- AIForge Technologies — \$22/module
- EdgeNova Inc. — \$24/module
- Cortexon AI — \$21/module

6. Vendor Information & Discovery

Vendor ID	Name	Component	MOQ	Lead Time	Price	Status
VND-201	TechEdge Systems	PoE Chipsets	2,000	5 weeks	\$4.50	RFI in progress

VND-202	IllumiTech Co.	IR LED Module	3,000	5 weeks	\$3.20	RFQ under review
VND-203	AIForge Tech	Edge AI Module	2,000	6 weeks	\$22.00	RFP submitted

7. Pricing & Budget

7.1 Component-Level Cost Estimates

Component	Est. Unit Cost	Qty	Est. Total	Buffer
4K CMOS Sensor	\$10.00	8,000	\$80,000	5%
Edge AI Module	\$22.00	8,000	\$176,000	10%
IP66 Housing	\$12.00	8,000	\$96,000	5%
IR LED	\$3.10	8,000	\$24,800	5%
PoE Chipset	\$4.50	8,000	\$36,000	5%

7.2 Total Budget & Contingency

- **Target Budget:** ~\$500,000
- **Contingency Reserve:** ~\$35,000 (7%)
- **Budget Owner:** Daniel Yu (CFO)

8. Key Dates & Milestones

Milestone	Target Date	Owner
Finalize BOM & Specs	April 12, 2025	Engineering Team
Issue RFIs	April 16, 2025	Priya Malhotra
RFQ & RFP Launch	April 13–14, 2025	Jacob Fisher
Proposal Deadlines	April 21–May 1	Vendors

Vendor Selection & Contracts	May 8, 2025	Procurement + Execs
Manufacturing Kickoff	June 1, 2025	Engineering